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Applicant
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December 27, 2000

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U.S. PATENT DOCUMENTS

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Exam. Initial	TRADEM	Document Number	Date	Name	Class	Sub Class	Filing Date
T.T.	AA	5,862,275	1/19/1999	Takeuchi et al. /			
7:7.	AB	5,636,072	6/3/1997	Shibata et al.			
1.1.	AC	5,774,257	6/30/1998	Shibata et al.			مسسے
$\tau\tau$.	AD	6,028,978	2/22/2000	Takeuchi et al.			
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7.7.	AH	6,091,182	7/18/2000	Takeuchi et al.			
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7.7.	AK	54-142089	5/11/1979	JP				~
T.T.		7-287176	10/31/1995	JР				~
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7.7.	AP	Kazuo Anzai, "Preparation of Electronic Materials by Electrophoretic Deposition," General Institute of Toshiba Corporation, Denki Kagaku 53, No. 1, 1985, pp 63-68.		
T.T.	AQ	Atsushi Goto et al., PbZrO ₂ /PbTiO ₃ Composite Ceramics Fabricated by Electrophoretic Deposition," Tokyo Metropolitan University, Tokyo Medical and Dental University, Proceedings of First Symposium on Higher-Order Ceramic Formation Method Based on Electrophoresis, 1998, pp 5 and 6.		
T.T.	AR	Kimihiro Yamashita, "Hybridization of Ceramics by Electrophoretic Deposition," Institute for Medical and Dental Engineering, Tokyo Medical and Dental University, Proceedings of First Symposium on Higher-Order Ceramic Formation Method Based on Electrophoresis, 1998, pp 23-24.		
Examiner TUYEN TRA Date Considered 3-17-02				

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